



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	BVDSS	Rds(on)	I _D T _A = +25°C
Q1	30V	460mΩ @ V _{GS} = 4.5V	1.1A
Qi	307	560mΩ @ V _{GS} = 2.5V	1.0A
02	201/	1000mΩ @ V _{GS} = -4.5V	-0.7A
Q2	-30V	1500mΩ @ V _{GS} = -2.5V	-0.6A

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

Applications

- Backlighting
- DC-DC converters
- Power-management functions

Features and Benefits

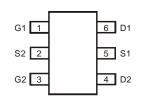
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMC3732UVTQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

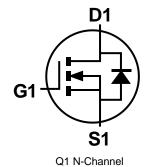
Mechanical Data

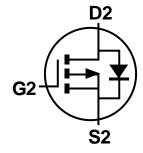
- Package: TSOT26
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208
- Weight: 0.013 grams (Approximate)





Top View





Q2 P-Channel

Ordering Information (Note 4)

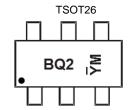
Top View

Part Number	Pankaga	Packing		
Fait Number	Package	Qty.	Carrier	
DMC3732UVTQ-7	TSOT26	3,000	Tape & Reel	
DMC3732UVTQ-13	TSOT26	10,000	Tape & Reel	

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



 $\begin{array}{l} \underline{BQ2} = Product\ Type\ Marking\ Code\\ \overline{Y}M = Date\ Code\ Marking\\ \overline{Y} = Year\ (ex:\ K = 2023)\\ M = Month\ (ex:\ 9 = September) \end{array}$

Date Code Key

Date Code Ney												
Year	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033	2034
Code	K	L	M	N	Р	R	S	Т	U	V	W	Х
					l I	l I		l I	l I			
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Q1 Value	Q2 Value	Unit		
Drain-Source Voltage	V _{DSS}	30	-30	V		
Gate-Source Voltage	Vgss	±8	±8	V		
Continuous Drain Current (Note 6) V _{GS} = 4.5V	ID	1.1 0.9	-0.7 -0.6	А		
Maximum Continuous Body Diode Forward Current	Is	0.73	-0.68	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	<u>s)</u>		Ірм	2.6	-1.9	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	0.54	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 5)	R _{0JA}	230	°C/W
Power Dissipation (Note 6)	PD	0.83	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 6)	Reja	150	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics – Q1 N-Channel (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 8)								
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V, I_{D} = 10\mu A$		
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V _{DS} = 30V, V _{GS} = 0V		
Gate-Source Leakage	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$		
ON CHARACTERISTICS (Note 8)								
Gate Threshold Voltage	V _{GS(TH)}	0.45	_	0.95	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$		
			290	460		$V_{GS} = 4.5V, I_{D} = 200mA$		
Static Drain-Source On-Resistance	RDS(ON)	_	340	560	mΩ	$V_{GS} = 2.5V, I_{D} = 100mA$		
			400	730		$V_{GS} = 1.8V, I_D = 75mA$		
Diode Forward Voltage	VsD		0.6	1.2	V	V _{DS} = V _{GS} , I _D = 300mA		
DYNAMIC CHARACTERISTICS (Note 9)								
Input Capacitance	Ciss		40.8	_), OEM), OM		
Output Capacitance	Coss		7.6		pF	$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz		
Reverse Transfer Capacitance	Crss	1	4.6	_		1 = 1.0IVII IZ		
Total Gate Charge	Qgs		0.9	_		\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\		
Gate-Source Charge	Q_{gd}	_	0.05	_	nC	$V_{GS} = 4.5V, V_{DS} = 15V,$ $I_{D} = 1A$		
Gate-Drain Charge	Ciss	_	0.3	_		ID = IA		
Turn-On Delay Time	td(on)	_	1.1	_				
Turn-On Rise Time	t _R	_	15.9	_		$V_{DS} = 10V, I_{D} = 1A$		
Turn-Off Delay Time	tD(OFF)	_	20.7	_	ns	$V_{GS} = 4.5V$, $R_{G} = 6\Omega$		
Turn-Off Fall Time	t _F		20.0	_				

Notes:

- 5. Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout.
- 6. Device mounted on FR-4 substrate PCB, 2oz copper, with 1inch square copper plate.
- 7. Repetitive rating, pulse width limited by junction temperature.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to production testing.



Electrical Characteristics - Q2 P-Channel (@TA = +25°C, unless otherwise specified.)

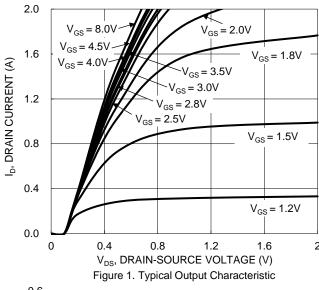
				1				
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 7)								
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$		
Zero Gate Voltage Drain Current	IDSS	_		-1	μΑ	$V_{DS} = -30V, V_{GS} = 0V$		
Gate-Source Leakage	Igss	_	_	±10	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$		
ON CHARACTERISTICS (Note 7)								
Gate Threshold Voltage	VGS(TH)	-0.5		-1.1	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$		
			0.72	1		$V_{GS} = -4.5V, I_D = -400mA$		
Static Drain-Source On-Resistance	RDS(ON)	_	0.86 1.0	1.5 2	Ω	$V_{GS} = -2.5V, I_{D} = -200mA$		
						$V_{GS} = -1.8V, I_D = -100mA$		
Diode Forward Voltage	VsD	_	-0.9	-1.2	V	V _G S = 0V, I _S = -300mA		
DYNAMIC CHARACTERISTICS (Note 8)								
Input Capacitance	Ciss	_	54	_				
Output Capacitance	Coss	_	10.9	_	pF	V _{DS} = -15V, V _{GS} = 0V f = 1.0MHz		
Reverse Transfer Capacitance	Crss	_	5.8	_		1 = 1.0IVII IZ		
Total Gate Charge	Qg	_	1.0	_		Vgs = -4.5V, Vps = -15V, Ip = -1A		
Total Gate Charge	Qg	_	1.6	_	nC	V 9V V 45V		
Gate-Source Charge	Qgs	_	0.2	_	nc	$V_{GS} = -8V, V_{DS} = -15V$ $I_{D} = -1A$		
Gate-Drain Charge	Qgd	_	0.1	_		ID = - IA		
Turn-On Delay Time	t _{D(ON)}	_	3.8	_				
Turn-On Rise Time	t _R	_	11	_		$V_{DD} = -10V$, $R_L = 10\Omega$		
Turn-Off Delay Time	tD(OFF)	_	45	_	ns	$V_{GS} = -4.5V$, $R_{G} = 6\Omega$		
Turn-Off Fall Time	tF	_	20	_	1			

Notes:

^{7.} Repetitive rating, pulse width limited by junction temperature. 8. Short duration pulse test used to minimize self-heating effect.



Q1 N-Channel



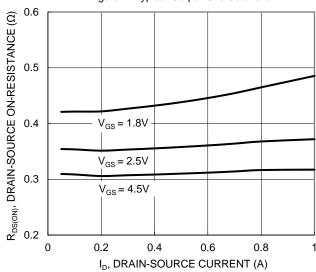


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

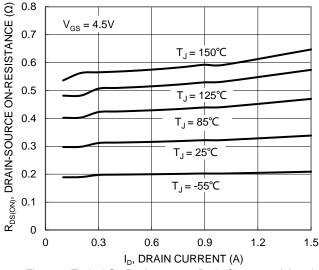
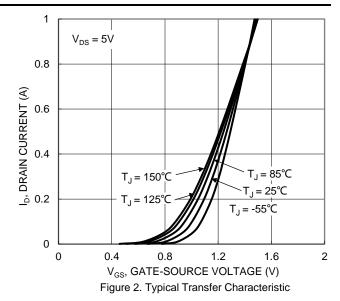
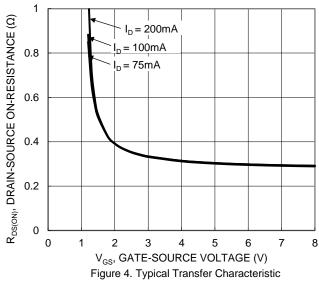


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





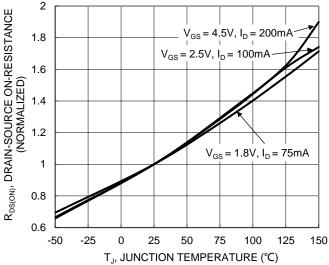


Figure 6. On-Resistance Variation with Junction Temperature



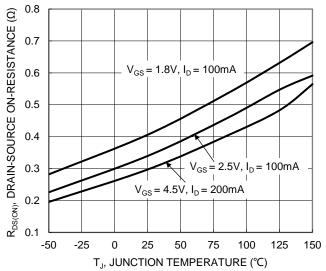


Figure 7. On-Resistance Variation with Junction Temperature

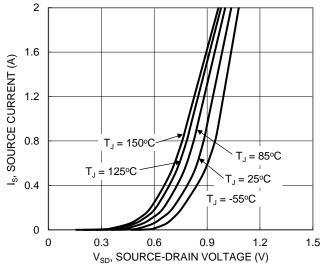


Figure 9. Diode Forward Voltage vs. Current

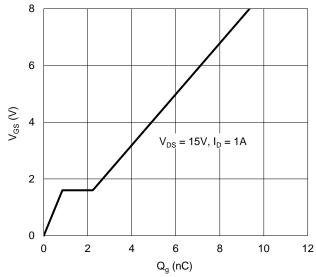


Figure 11. Gate Charge

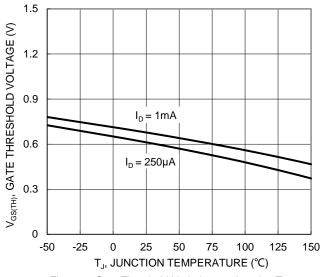
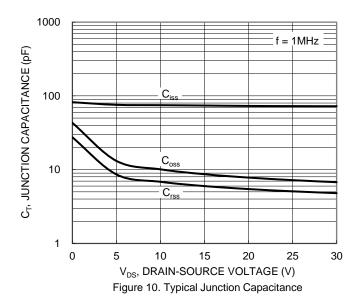
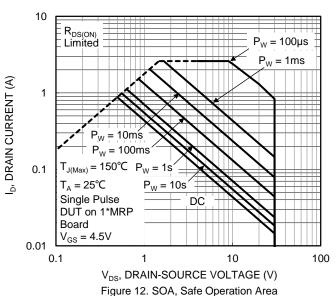


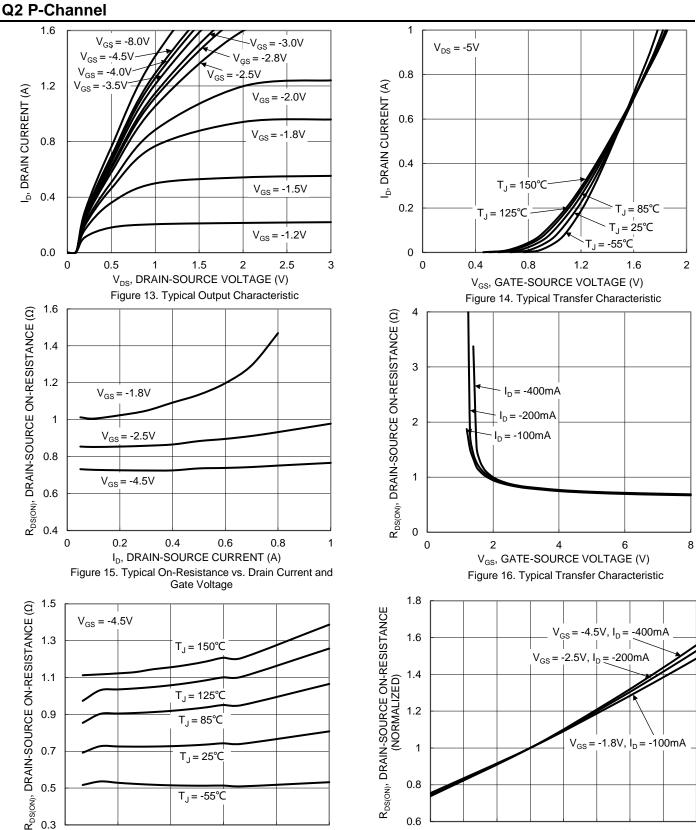
Figure 8. Gate Threshold Variation vs. Junction Temperature





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I_D, DRAIN CURRENT (A) Figure 17. Typical On-Resistance vs. Drain Current and Junction Temperature

0.9

1.2

1.5

0.6

 $T_J = -55^{\circ}C$

50

0.3

0

0.3

0.6

-50

-25

0

25

75

100

125

150



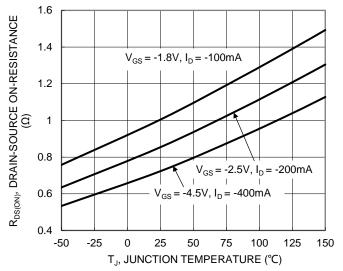


Figure 19. On-Resistance Variation with Junction Temperature

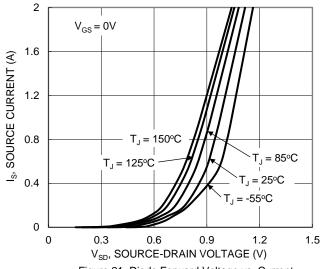
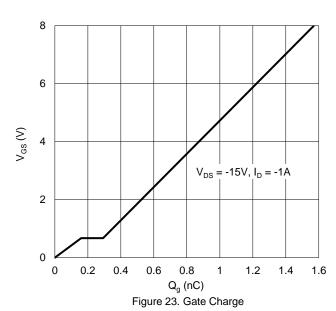
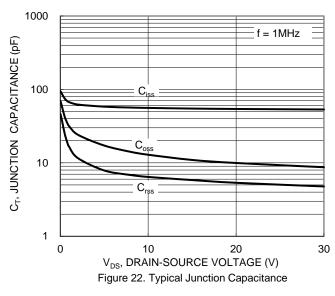


Figure 21. Diode Forward Voltage vs. Current



1.5 $V_{\text{GS(TH)}},$ GATE THRESHOLD VOLTAGE (V) 1.2 0.9 $I_D = -1mA$ 0.6 $I_D = -250 \mu A$ 0.3 0 -25 0 25 50 75 100 -50 125 150 T_J, JUNCTION TEMPERATURE (°C)

Figure 20. Gate Threshold Variation vs. Junction Temperature



10 R_{DS(ON)} Limited $P_{yy} = 100 \mu s$ 1 ID, DRAIN CURRENT (A) $P_W = 10ms$ 0.1 $T_{J(Max)} = 150$ °C T_A = 25°C 0.01 Single Pulse DUT on 1*MRP Board $V_{GS} = -4.5V$ 0.001 0.1 10 100 V_{DS} , DRAIN-SOURCE VOLTAGE (V) Figure 24. SOA, Safe Operation Area



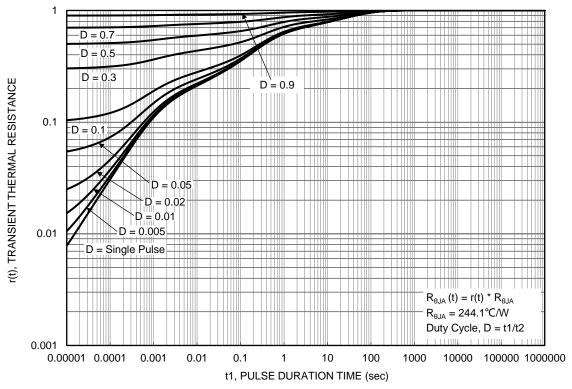


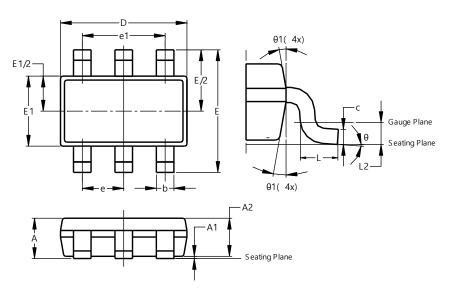
Figure 25. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26

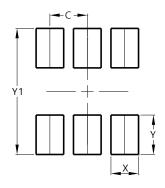


TSOT26								
Dim	Min	Max	Тур					
Α	-	1.00	_					
A 1	0.010	0.100	-					
A2	0.840	0.900	-					
D	2.800	3.000	2.900					
E	2	.800 BS	С					
E1	1.500	1.700	1.600					
b	0.300	0.450	-					
С	0.120	0.200	-					
е	0.950 BSC							
e1	1	1.900 BSC						
L	0.30 0.50		-					
L2	0.250 BSC							
θ	0°	8°	4°					
θ1	4°	12°	_					
Δ	II Dimen	sions in	mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.200



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